

APPENDIX:

The Appendix includes the following item(s):

- ☒ - a new or amended Abstract of the Disclosure
- ☒ - a Substitute Specification
- ☒ - a marked-up copy of the originally-filed specification

ABSTRACT OF THE DISCLOSURE

A curable composition comprises at least one of (A), (B), and (C) and further contains the following (D) (provided that when (C) is not contained, both (A) and (B) are contained). (A): A silicon-containing polymer whose components having an average molecular weight of 1,000 or lower is 20 wt.% or lower and which has a reactive group A^1 and one or more Si-O-Si bonds. (B): A silicon-containing polymer whose components having an average molecular weight of 1,000 or lower is 20 wt.% or lower and which has an Si-H group and one or more Si-O-Si bonds. (C): A silicon-containing polymer in which the content of components having an average molecular weight of 1,000 or lower is 20 wt.% or lower and which has A^1 , an Si-H group, and one or more Si-O-Si bonds. (D): A platinum catalyst for curing reaction. A^1 is any of Si- R^1 , Si-O- R^2 , and Si- R^3 -OCOC(R^4)=CH₂; R^1 and R^2 is alkenyl, R^3 is alkylene and/or arylene, and R^4 is hydrogen or methyl.